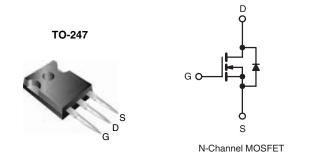


Vishay Siliconix

Power MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------------------|-----------------------------|-----|--|--|--|
| V _{DS} (V) | 500 | 500 | | | |
| $R_{DS(on)}\left(\Omega\right)$ | V _{GS} = 10 V 0.40 | | | | |
| Q _g (Max.) (nC) | 64 | | | | |
| Q _{gs} (nC) | 16 | | | | |
| Q _{gd} (nC) | 26 | | | | |
| Configuration | Single | | | | |



FEATURES

 Low Gate Charge Q_g Results in Simple Drive Requirement



• Improved Gate, Avalanche and Dynamic dV/dt Ruggedness



- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Lead (Pb)-free Available

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptable Power Supply
- · High Speed Power Switching

TYPICAL SMPS TOPOLOGIES

- Two Transistor Forward
- Half Bridge, Full Bridge
- PFC Boost

| ORDERING INFORMATION | | | | |
|----------------------|--------------|--|--|--|
| Package | TO-247 | | | |
| Lead (Pb)-free | IRFP450APbF | | | |
| | SiHFP450A-E3 | | | |
| SnPb | IRFP450A | | | |
| SIIFD | SiHFP450A | | | |

| PARAMETER | SYMBOL | LIMIT | UNIT | | |
|--|--|-----------------|------------------|----------|--|
| Drain-Source Voltage | | V_{DS} | 500 | V | |
| Gate-Source Voltage | | V_{GS} | ± 30 | 7 V | |
| Continuous Drain Current | V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$ | I_ | 14 | | |
| Continuous Diain Current | $T_C = 100 ^{\circ}$ C | I _D | 8.7 | Α | |
| Pulsed Drain Current ^a | | I _{DM} | 56 | 1 | |
| Linear Derating Factor | | 1.5 | W/°C | | |
| Single Pulse Avalanche Energy ^b | E _{AS} | 760 | mJ | | |
| Repetitive Avalanche Currenta | I _{AR} | 14 | Α | | |
| Repetitive Avalanche Energy ^a | | E _{AR} | 19 | mJ | |
| Maximum Power Dissipation | P_{D} | 190 | W | | |
| Peak Diode Recovery dV/dtc | dV/dt | 4.1 | V/ns | | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to + 150 | °C | | |
| Soldering Recommendations (Peak Temperature) | for 10 s | | 300 ^d | 7 | |
| Mounting Toyaus | 6-32 or M3 screw | | 10 | lbf ⋅ in | |
| Mounting Torque | 6-32 OF IVI3 SCIEW | | 1.1 | N⋅m | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Starting T_J = 25 °C, L = 7.8 mH, R_G = 25 $\Omega,\,I_{AS}$ = 14 A (see fig. 12).
- c. $I_{SD} \leq$ 14 A, $dI/dt \leq$ 130 A/µs, $V_{DD} \leq V_{DS},\, T_{J} \leq$ 150 °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFP450A, SiHFP450A

Vishay Siliconix



| THERMAL RESISTANCE RATINGS | | | | | |
|-------------------------------------|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 40 | | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.24 | - | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 0.65 | | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|---|---|------|------|------------------|------|
| Static | | <u>.</u> | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0$ |) V, I _D = 250 μA | 500 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | to 25 °C, I _D = 1 mA | - | 0.58 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V$ | ' _{GS} , I _D = 250 μA | 2.0 | - | 4.0 | V |
| Gate-Source Leakage | I _{GSS} | V _G | _{SS} = ± 30 V | - | - | ± 100 | nA |
| Zoro Coto Voltago Drain Current | 1 | V _{DS} = 5 | 00 V, V _{GS} = 0 V | - | - | 25 | μΑ |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 400 V, V | V _{GS} = 0 V, T _J = 125 °C | - | - | 250 | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 8.4 A ^b | - | - | 0.40 | Ω |
| Forward Transconductance | 9 _{fs} | $V_{DS} = 5$ | 60 V, I _D = 8.4 A ^b | 7.8 | - | - | S |
| Dynamic | | <u>.</u> | | | | | |
| Input Capacitance | C _{iss} | V | ′ _{GS} = 0 V, | - | 2038 | - | |
| Output Capacitance | C _{oss} | V | $V_{DS} = 25 \text{ V},$ | | 307 | - | 1 |
| Reverse Transfer Capacitance | C _{rss} | f = 1.0 | MHz, see fig. 5 | - | 10 | - | 1 _ |
| Output Capacitance | C _{oss} | V _{GS} = 0 V; V _{DS} = 1.0 V, f = 1.0 MHz | | | 2859 | | pF |
| Output Capacitance | C _{oss} | V _{GS} = 0 V; V _{DS} = 400 V, f = 1.0 MHz | | | 81 | | |
| Effective Output Capacitance | C _{oss} eff. | V _{GS} = 0 V; V _{DS} = 0 V to 400 V ^c | | | 96 | | |
| Total Gate Charge | Qg | V _{GS} = 10 V | | - | - | 64 | |
| Gate-Source Charge | Q_{gs} | | | - | - | 16 | nC |
| Gate-Drain Charge | Q_{gd} | | goo ngi o ana io | - | - | 26 | 1 |
| Turn-On Delay Time | t _{d(on)} | | | - | 15 | - | |
| Rise Time | t _r | V _{DD} = 2 | 50 V, I _D = 14 A, | - | 36 | - | no |
| Turn-Off Delay Time | t _{d(off)} | | $V_{DD} = 250 \text{ V}, I_D = 14 \text{ A},$ $R_G = 6.2 \Omega, R_D = 17 \Omega, \text{ see fig. } 10^{\text{b}}$ | | 35 | - | ns |
| Fall Time | t _f | 1 | | - | 29 | - | |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 14 | A |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 56 | |
| Body Diode Voltage | V _{SD} | T _J = 25 °C, I _S = 14 A, V _{GS} = 0 V ^b | | - | - | 1.4 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 14 A, dl/dt = 100 A/µs ^b | | - | 487 | 731 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 3.9 | 5.8 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D) | | | | L _D) | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %. c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80 % V_{DS} .



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

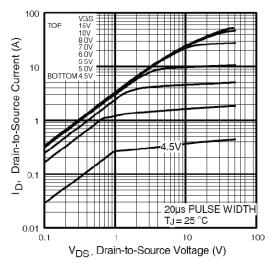


Fig. 1 - Typical Output Characteristics

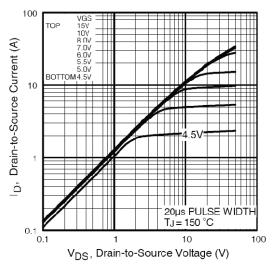


Fig. 2 - Typical Output Characteristics

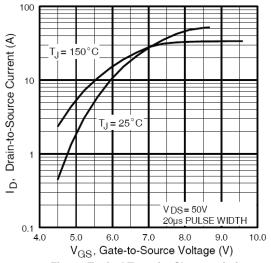


Fig. 3 - Typical Transfer Characteristics

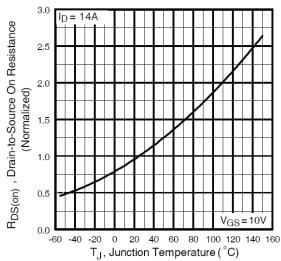


Fig. 4 - Normalized On-Resistance vs. Temperature

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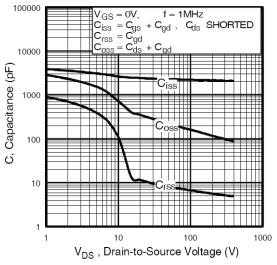


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

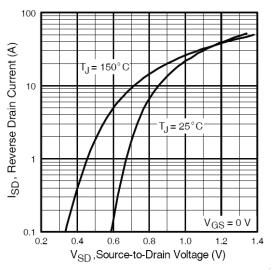


Fig. 7 - Typical Source-Drain Diode Forward Voltage

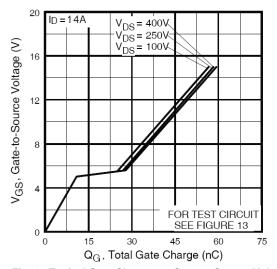


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

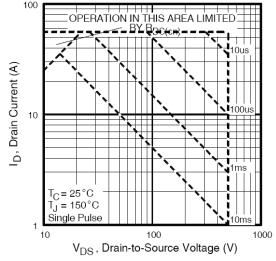


Fig. 8 - Maximum Safe Operating Area



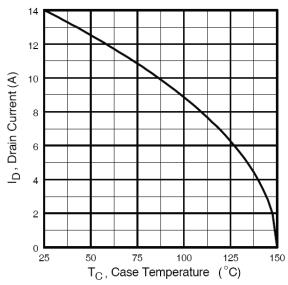


Fig. 9 - Maximum Drain Current vs. Case Temperature

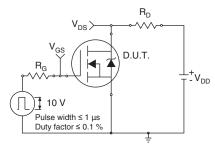


Fig. 10a - Switching Time Test Circuit

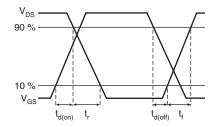


Fig. 10b - Switching Time Waveforms

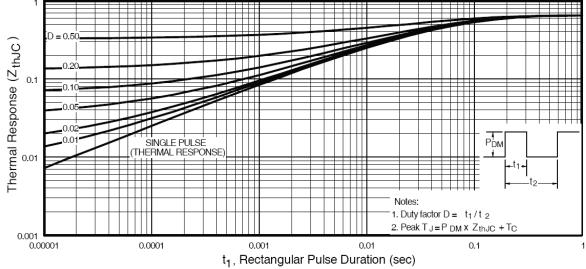


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

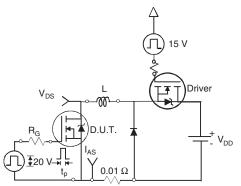


Fig. 12a - Unclamped Inductive Test Circuit

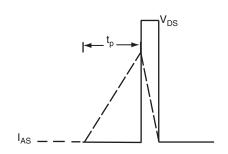


Fig. 12b - Unclamped Inductive Waveforms

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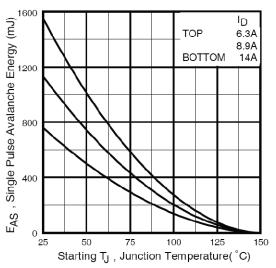


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

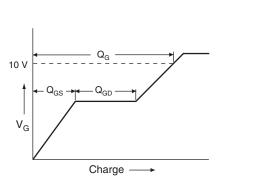


Fig. 13a - Basic Gate Charge Waveform

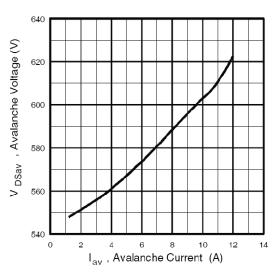


Fig. 12d - Typical Drain-to-Source Voltage vs. **Avalanche Current**

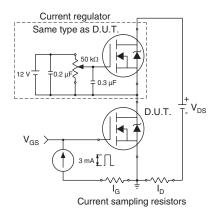
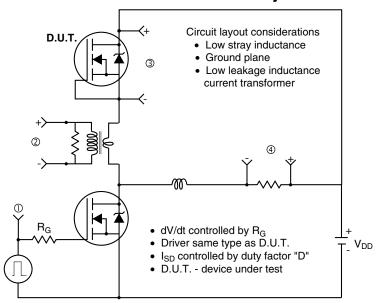
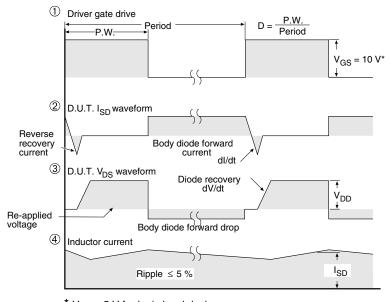


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit





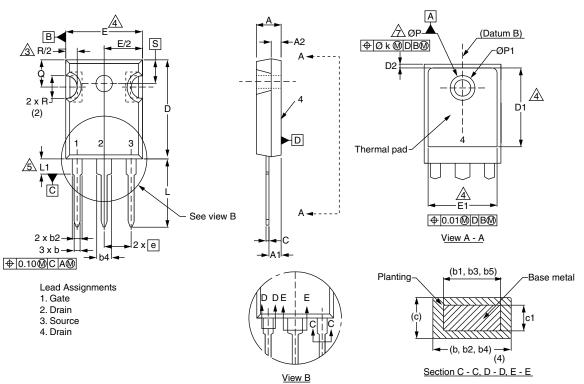
* $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-247AC (High Voltage)



| | MILLIMETERS | | INC | HES |
|------|-------------|-------|-------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| Α | 4.58 | 5.31 | 0.180 | 0.209 |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 |
| A2 | 1.17 | 2.49 | 0.046 | 0.098 |
| b | 0.99 | 1.40 | 0.039 | 0.055 |
| b1 | 0.99 | 1.35 | 0.039 | 0.053 |
| b2 | 1.53 | 2.39 | 0.060 | 0.094 |
| b3 | 1.65 | 2.37 | 0.065 | 0.093 |
| b4 | 2.42 | 3.43 | 0.095 | 0.135 |
| b5 | 2.59 | 3.38 | 0.102 | 0.133 |
| С | 0.38 | 0.86 | 0.015 | 0.034 |
| c1 | 0.38 | 0.76 | 0.015 | 0.030 |
| D | 19.71 | 20.82 | 0.776 | 0.820 |
| D1 | 13.08 | - | 0.515 | - |

| | MILLIMETERS | | INC | HES |
|--------------------|-------------|-------|-------------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| D2 | 0.51 | 1.30 | 0.020 | 0.051 |
| E | 15.29 | 15.87 | 0.602 | 0.625 |
| E1 | 13.72 | ı | 0.540 | ı |
| е | 5.46 | BSC | 0.215 | BSC |
| Øk | 0.254 | | 0.010 | |
| L | 14.20 | 16.25 | 0.559 | 0.640 |
| L1 | 3.71 | 4.29 | 0.146 | 0.169 |
| N | 7.62 | BSC | C 0.300 BSC | |
| ØP | 3.51 | 3.66 | 0.138 | 0.144 |
| Ø P1 | - | 7.39 | - | 0.291 |
| Q | 5.31 | 5.69 | 0.209 | 0.224 |
| R | 4.52 | 5.49 | 0.178 | 0.216 |
| S | 5.51 BSC | | 0.217 BSC | |
| 0.01 800 0.217 800 | | | | |

ECN: X13-0103-Rev. D, 01-Jul-13

DWG: 5971

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Contour of slot optional.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions D1 and E1.
 5. Lead finish uncontrolled in L1.
- 6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").
- 7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.
- 8. Xian and Mingxin actually photo.





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